

Feature

- 100V,145A
 - $R_{DS (ON)} \le 4.2 m \Omega @V_{GS} = 10V TYP:3.7$
- Advanced Trench Power MOSFET
- Provide Excellent R_{DS(ON)} And Low Gate Charge

G S



Marking and pin assignment

Application

- DC/DC Converter
- Load Switch for Portable Devices
- Battery Switch
- Rectifier

Package Marking and Ordering Information

Device Marking	evice Marking Device		Reel Size	Tape width	Quantity (PCS)
G042N01	APG042N01	TO-220		-	1000

ABSOLUTE MAXIMUM RATINGS (T_J=25℃ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V _{DS}	100	V
Gate-Source Voltage	V _{GS}	±20	V
Continuous Drain Current (T _C =25℃)	I _D	145	A
Continuous Drain Current (T _C =100℃)	I _D	105	Α
Pulsed Drain Current (1)	I _{DM}	380	Α
Single Pulsed Avalanche Energy (2)	Eas	660	mJ
Power Dissipation	P _D	215	W
Thermal Resistance from Junction to Case	Rejc	0.44	°C/W
Junction Temperature	TJ	150	°C
Storage Temperature	T _{STG}	-55~ +150	°C



MOSFET ELECTRICAL CHARACTERISTICS(T_J=25℃ unless otherwise noted)

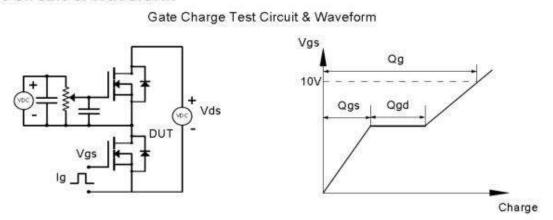
Parameter	Symbol	Test Condition	Min	Туре	Max	Unit
Static Characteristics						
Drain-source breakdown voltage V _{(BR)DS}		$V_{GS} = 0V, I_D = 250\mu A$	100	-	-	V
Zero gate voltage drain current	DSS	V _{DS} =100V, V _{GS} = 0V	-	-	1	μΑ
Gate-body leakage current	I _{GSS}	$V_{GS} = \pm 20V$, $V_{DS} = 0V$	-	-	±100	nA
Gate threshold voltage ⁽³⁾	$V_{GS(th)}$	V _{DS} =V _{GS} , I _D =250μA	2	3	4	V
Drain-source on-resistance ⁽³⁾	R _{DS(on)}	V _{GS} =10V, I _D =70A	-	3.7	4.2	mΩ
Forward tranconductance ⁽³⁾	g FS	V _{DS} =10V, I _D =70A	-	122	-	S
Dynamic characteristics						
Input Capacitance	C _{iss}		-	5678	-	pF
Output Capacitance	Coss	V _{DS} =50V, V _{GS} =0V, f =1MHz	-	673	-	
Reverse Transfer Capacitance	C _{rss}	_	-	27	-	
Switching characteristics						
Turn-on delay time	t _{d(on)}		-	25	-	ns
Turn-on rise time	tr	√ V _{DD} =50V, I _D =70A,	-	33	-	
Turn-off delay time	$t_{\sf d(off)}$	V_{GS} =10V, R_G =25 Ω	-	37	-	
Turn-off fall time	t _f	_	-	18	-	
Total Gate Charge	Qg	\/D0_50\/_ID_70A	-	82	-	
Gate-Source Charge	Qgs	VDS=50V, ID=70A,	-	22	-	nC
Gate-Drain Charge	Qgd	- VGS=10V	-	20	-	
Source-Drain Diode characteristics				•		
Diode Forward voltage ⁽³⁾	V _{DS}	V _{GS} =0V, I _S =140A	-	-	1.2	V
Diode Forward current ⁽⁴⁾			-	-	140	Α
Reverse recovery time	Reverse recovery time Trr Is=70			71		ns
Reverse recovery charge	Qrr	Is=70A,V _{GS} =0V,dI _F /dt=100A/us		144		nC

Notes:

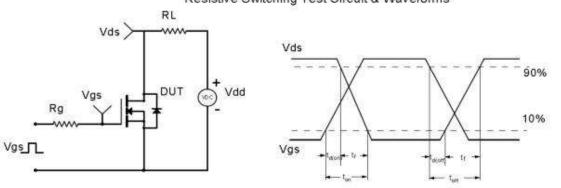
- 1. Repetitive Rating: pulse width limited by maximum junction temperature
- 2. EAS Condition:TJ=25 $^{\circ}$ C,VDD=50V,RG=20 $^{\Omega}$,L=0.5mH
- 3. Pulse Test: pulse width≤300µs, duty cycle≤2%
- 4. Surface Mounted on FR4 Board,t≤10 sec



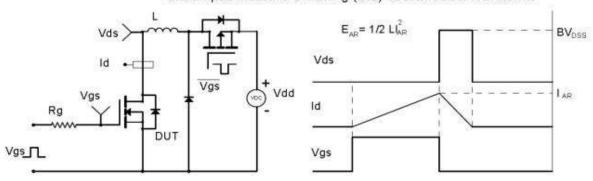
Test Circuit & Waveform



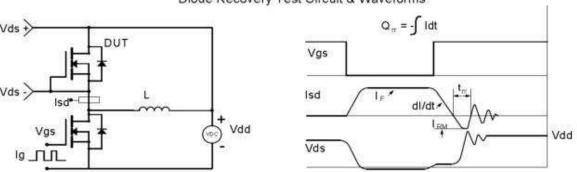
Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching (UIS) Test Circuit & Waveforms



Diode Recovery Test Circuit & Waveforms





Typical Electronic and Thermal Characteristics

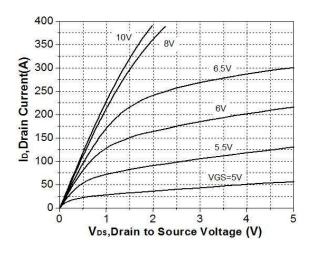


Figure 1. On-Region Characteristics

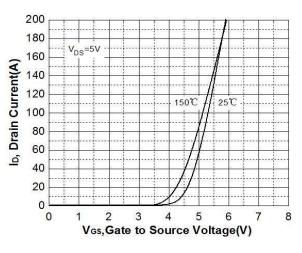


Figure 2. Transfer Characteristics

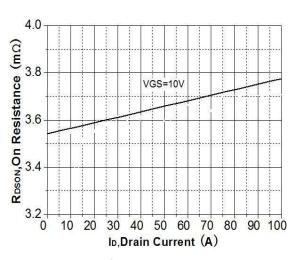


Figure 3. On-Resistance Variation vs Drain Current

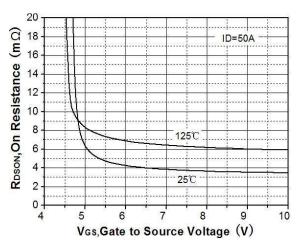


Figure 4. On-Resistance Vs Gate to Source Voltage

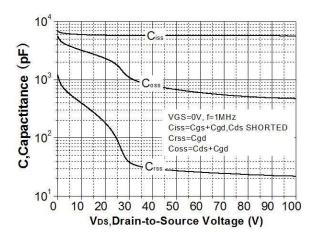


Figure 5. Capacitance Characteristics

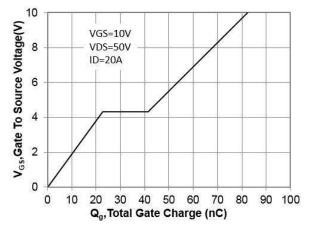


Figure 6. Gate Charge Characteristics



Typical Electronic and Thermal Characteristics

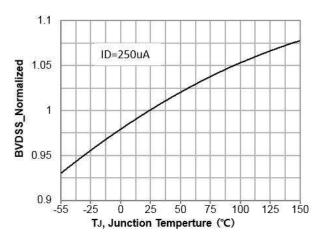


Figure 7. Breakdown Voltage Variation vs Temperature

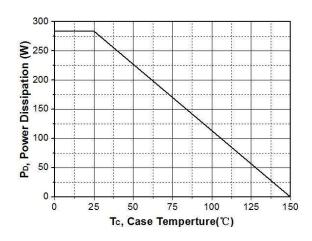


Figure 9. Power Dissipation

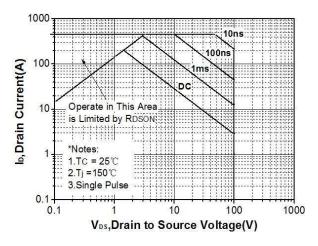


Figure 11. Maximum Safe Operating Area

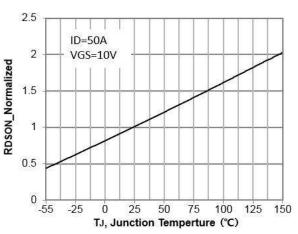


Figure 8. On-Resistance Variation vs Temperature

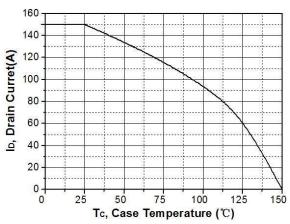


Figure 10. Drain Current Derating

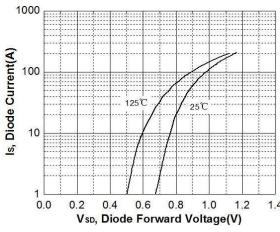
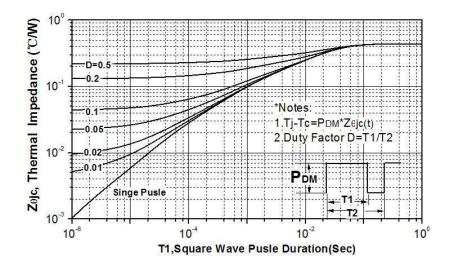


Figure 12. Body-diode Forward Characteristics

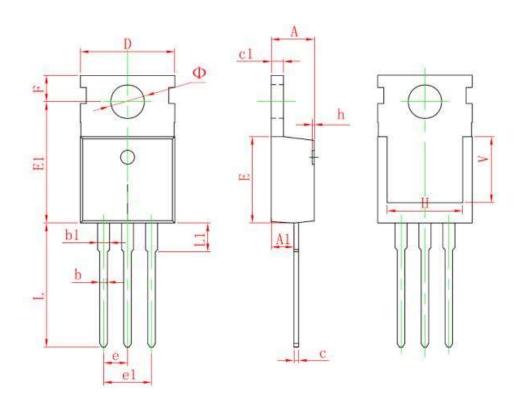


Typical Electronic and Thermal Characteristics





TO220 Package Information



Comple at	Dimensions In Millimeters		Dimensions In Inches			
Symbol	Min.	Max.	Min.	Max.		
Α	4.400	4.600	0.173	0.181		
A1	2.250	2.550	0.089	0.100		
b	0.710	0.910	0.028	0.036		
b1	1.170	1.370	0.046	0.054		
С	0.330	0.650	0.013	0.026		
c1	1.200	1.400	0.047	0.055		
D	9.910	10.250	0.390	0.404		
E	8.950	9.750	0.352	0.384		
E1	12.650	13.050	0.498	0.514		
е	2.540	2.540 TYP.		0.100 TYP.		
e1	4.980	5.180	0.196	0.204		
F	2.650	2.950	0.104	0.116		
Н	7.900	8.100	0.311	0.319		
h	0.000	0.300	0.000	0.012		
L	12.900	13.400	0.508	0.528		
L1	2.850	3.250	0.112	0.128		
V	6.900 REF.		0.276	REF.		
Ф	3.400	3.800	0.134	0.150		

APG042N01

N-Channel Shielding-Gate Mosfet



Revision History

Revision	Release	Remark
V1.0	2023/08/10	Initial Release

Disclaimer

The information given in this document describes the independent performance of the product, but similar performance is not guaranteed under other working conditions, and cannot be guaranteed when installed with other products or equipment. To achieve the required performance of the product in actual scenarios, the customer should conduct a complete application test to assess the functionality of the product.

Allpower assumes no responsibility for equipment failures result from using products at values that exceed the ratings, operating conditions, or other parameters listed in the product specifications.

The product described in this specification is not applicable for aerospace or other applications which requires high reliability. Customers using or selling these products for use in medical, life-saving, or life-sustaining applications do so at their own risk and agree to fully indemnify.

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